# International Rectifier

#### **AUTOMOTIVE GRADE**

### AUIRFR2905Z

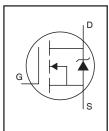
HEXFET® Power MOSFET

#### **Features**

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified\*

#### **Description**

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



	LOWE	MOSI LI
V <sub>(BR)DSS</sub>		55V
R <sub>DS(on)</sub>	typ.	11.1m $\Omega$
	max.	14.5m $Ω$
I <sub>D (Silicon Limited)</sub>		<b>59A</b> ⑨
I <sub>D (Package Limited)</sub>		42A



		D-Pak AUIRFR2905Z		
G D		S		
Gate		Drain		Source

#### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Ambient temperature (Tx) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)	59 <sup>®</sup>	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)	42⑨	Α
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Package Limited)	42	
I <sub>DM</sub>	Pulsed Drain Current ①	240	
P <sub>D</sub> @T <sub>C</sub> = 25°C	Power Dissipation	110	W
	Linear Derating Factor	0.72	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy(Thermally limited) ②	55	mJ
E <sub>AS</sub> (Tested )	Single Pulse Avalanche Energy Tested Value ®	82	
I <sub>AR</sub>	Avalanche Current ①	See Fig.12a, 12b, 15, 16	А
E <sub>AR</sub>	Repetitive Avalanche Energy ⑤		mJ
T <sub>J</sub>	Operating Junction and	-55 to + 175	
T <sub>STG</sub>	Storage Temperature Range		°C
-	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

#### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		1.38	
$R_{\theta JA}$	Junction-to-Ambient (PCB mount) ♡		50	°C/W
$R_{\theta JA}$	Junction-to-Ambient		110	

HEXFET® is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/ www.irf.com/

#### Static Electrical Characteristics @ $T_J = 25$ °C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.053		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		11.1	14.5	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 36A ③
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250\mu A$
gfs	Forward Transconductance	20			S	$V_{DS} = 25V, I_D = 36A$
$R_G$	Gate Input Resistance		1.3		Ω	f = 1MHz, open drain
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20		$V_{DS} = 55V, V_{GS} = 0V$
				250	μΑ	$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			200	n^	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-200	nA	V <sub>GS</sub> = -20V

#### Dynamic Electrical Characteristics @ $T_J = 25$ °C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$Q_g$	Total Gate Charge		29	44		$I_D = 36A$
$Q_{gs}$	Gate-to-Source Charge		7.7		nC	$V_{DS} = 44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		12		1	V <sub>GS</sub> = 10V ③
t <sub>d(on)</sub>	Turn-On Delay Time		14			$V_{DD} = 28V$
t <sub>r</sub>	Rise Time		66		l	$I_D = 36A$
t <sub>d(off)</sub>	Turn-Off Delay Time		31		ns	$R_G = 15 \Omega$
t <sub>f</sub>	Fall Time		35		1	V <sub>GS</sub> = 10V ③
L <sub>D</sub>	Internal Drain Inductance		4.5			Between lead, 6mm (0.25in.)
L <sub>S</sub>	Internal Source Inductance		7.5		nH	from package and center of die contact
C <sub>iss</sub>	Input Capacitance		1380			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		240		1	$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		120		рF	f = 1.0MHz
C <sub>oss</sub>	Output Capacitance		820			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C <sub>oss</sub>	Output Capacitance		190		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance		300		1	$V_{GS} = 0V$ , $V_{DS} = 0V$ to 44V $\oplus$

#### **Diode Characteristics**

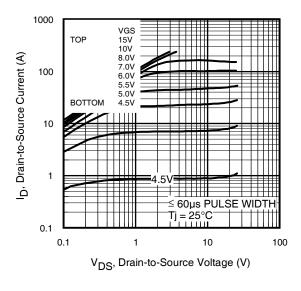
	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			429		MOSFET symbol
	(Body Diode)			429	Α	showing the
I <sub>SM</sub>	Pulsed Source Current			240		integral reverse
	(Body Diode) ①			240		p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$ , $I_S = 36A$ , $V_{GS} = 0V$ ③
t <sub>rr</sub>	Reverse Recovery Time		23	35	ns	$T_J = 25$ °C, $I_F = 36A$ , $V_{DD} = 28V$
Q <sub>rr</sub>	Reverse Recovery Charge		16	24	nC	di/dt = 100A/μs ③
t <sub>on</sub>	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

## Qualification Information<sup>†</sup>

		Automotive (per AEC-Q101) ††					
Qualification Level		Comments: This part number(s) passe Automotive qualification. IR's Industrial an Consumer qualification level is granted be extension of the higher Automotive level.					
Moisture Sensitiv	Moisture Sensitivity Level		D PAK MSL1				
	Machine Model	Class M3(400V)					
		(per AEC-Q101-002)					
F0D	Human Body Model	Class H1A(500V)					
ESD			(per AEC-Q101-001)				
	Charged Device	Class C5 (1125V)					
Model		(per AEC-Q101-005)					
RoHS Compliant		Yes					

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

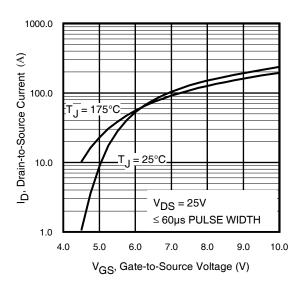
<sup>††</sup> Exceptions to AEC-Q101 requirements are noted in the qualification report.



TOP 15V 8.0V 7.0V 8.0V 7.0V 6.0V 6.0V 5.5V 5.5V 5.5V 5.5V 6.0V 6.

Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics





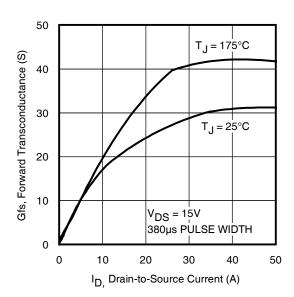
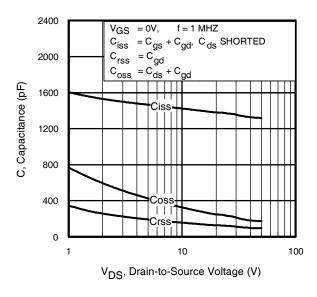


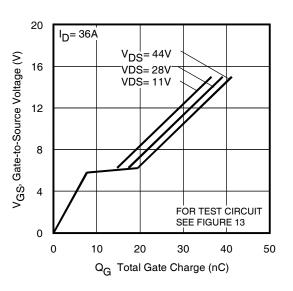
Fig 4. Typical Forward Transconductance Vs. Drain Current

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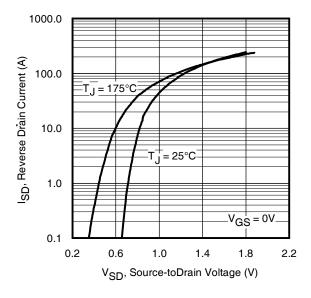
## AUIRFR2905Z



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

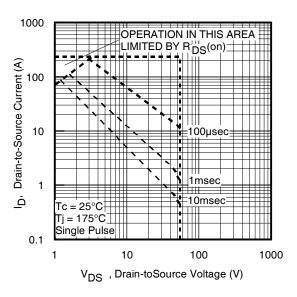
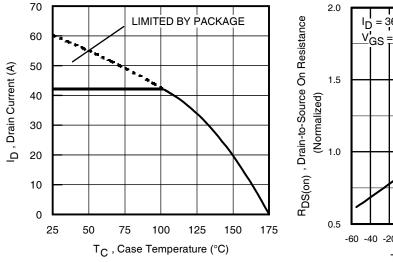


Fig 8. Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature

**Fig 10.** Normalized On-Resistance Vs. Temperature

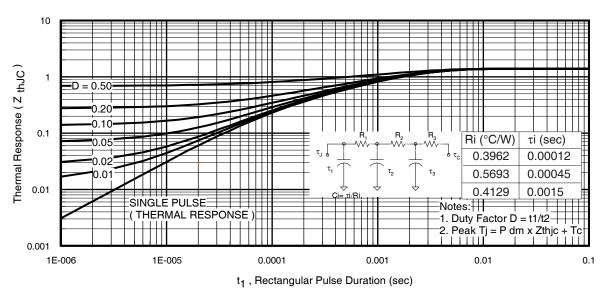


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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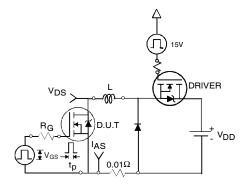


Fig 12a. Unclamped Inductive Test Circuit

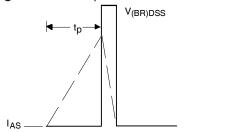


Fig 12b. | Unclamped Inductive Waveforms

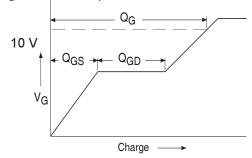
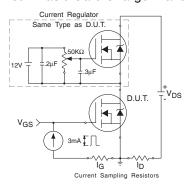


Fig 13a. Basic Gate Charge Waveform



**Fig 13b.** Gate Charge Test Circuit www.irf.com

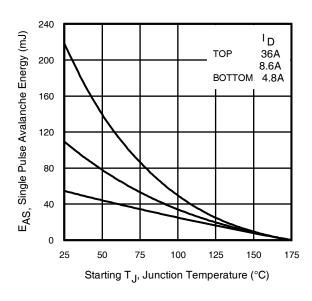


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

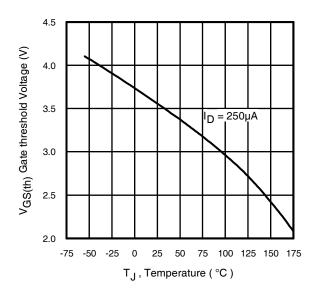


Fig 14. Threshold Voltage Vs. Temperature

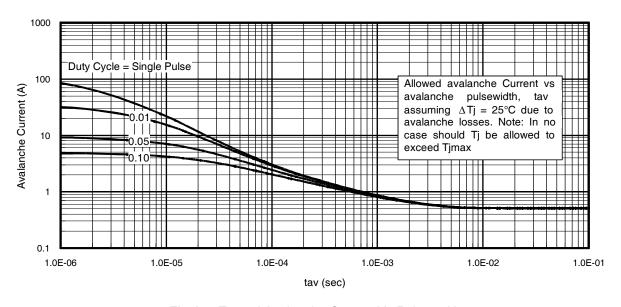
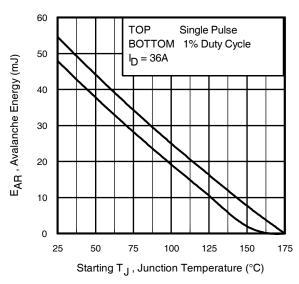


Fig 15. Typical Avalanche Current Vs. Pulsewidth



**Fig 16.** Maximum Avalanche Energy Vs. Temperature

## Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption: Purely a thermal phenomenon and failure occurs at a temperature far in excess of T<sub>jmax</sub>. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long  $asT_{jmax}$  is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I<sub>av</sub> = Allowable avalanche current.
- 7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed  $T_{jmax}$  (assumed as 25°C in Figure 15, 16).  $t_{av}$  = Average time in avalanche.
  - $D = Duty cycle in avalanche = t_{av} \cdot f$

 $Z_{th,JC}(D, t_{av})$  = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \; (ave)} &= 1/2 \; (\; 1.3 \cdot \text{BV} \cdot \text{I}_{aV}) = \triangle T / \; Z_{thJC} \\ I_{av} &= 2\triangle T / \; [1.3 \cdot \text{BV} \cdot Z_{th}] \\ E_{AS \; (AR)} &= P_{D \; (ave)} \cdot t_{av} \end{split}$$

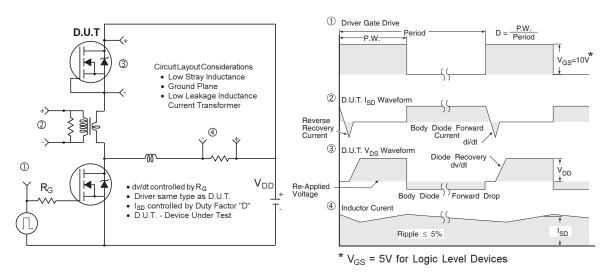


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

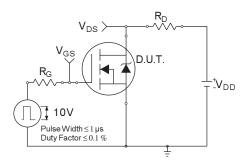


Fig 18a. Switching Time Test Circuit

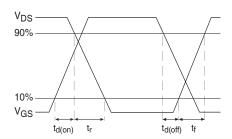
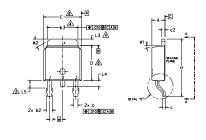


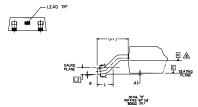
Fig 18b. Switching Time Waveforms

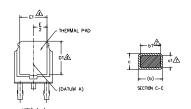
#### International IOR Rectifier

#### D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)







- NOTES:
  1.— DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].

  \$\rightarrowsalpha Lead dimension uncontrolled in L5.

  \$\rightarrowsalpha DIMENSION D1, E1, L3 & b3 ESTABUSH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- [D.15 AND 0.25] FROM THE LEAD TIP.

  \$\hfill\text{DIMENSON D & E DO NOT INCLUSE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.

  \$\hfill\text{DIMENSON DI & c1 APPLIED TO BASE METAL ONLY.}

  \$\hfill\text{DATIM A & B TO BE DETERMINED AT DATUM PLANE H.}

- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

S M		N			
B	MILLIM	MILLIMETERS		HES	O T E S
0 L	MIN.	MAX.	MIN.	MAX.	E S
Α	2.18	2.39	.086	.094	
A1	-	0.13	-	.005	
b	0.64	0.89	.025	.035	
ь1	0.65	0,79	.025	.031	7
b2	0.76	1,14	.030	.045	
b3	4.95	5,46	,195	.215	4
С	0.46	0.61	.018	.024	
c1	0,41	0,56	.016	.022	7
c2	0.46	0.89	.018	.035	
D	5.97	6.22	.235	.245	6
D1	5.21	-	.205	-	4
Ε	6.35	6.73	.250	.265	6
E1	4.32	-	.170	-	4
e	2.29	BSC	.090	BSC	
н	9.40	10,41	.370	.410	
L	1,40	1.78	.055	.070	
L1	2.74	BSC	.108	REF.	
L2	0.51	BSC	.020	BSC	
L3	0.89	1.27	.035	.050	4
L4	-	1.02	-	.040	
L5	1,14	1,52	.045	.060	3
ø	0,	10*	0*	10*	
Ø1	0.	15*	0.	15*	
ø2	25*	35*	25*	35*	

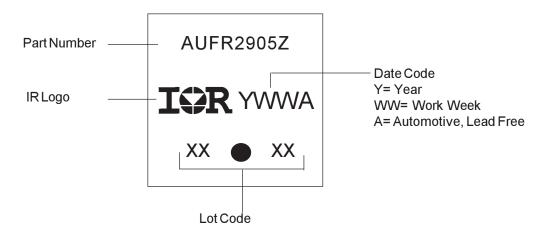
#### LEAD ASSIGNMENTS

<u>HEXFET</u>

IGBT & CoPAK

1.- GATE 2.- COLLECTOR 3.- EMITTER 4.- COLLECTOR

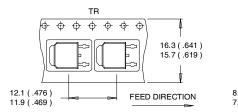
## D-Pak (TO-252AA) Part Marking Information

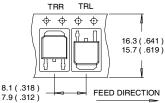


Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

#### D-Pak (TO-252AA) Tape & Reel Information

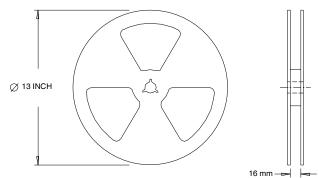
Dimensions are shown in millimeters (inches)





#### NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
  3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481.

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by  $T_{Jmax}$ , starting  $T_J = 25^{\circ}C$ , L = 0.08mH ⑥  $R_G = 25\Omega$ ,  $I_{AS} = 36A$ ,  $V_{GS} = 10V$ . Part not recommended for use above this value.
- 4 Coss eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$  .
- S Limited by T<sub>Jmax</sub>, see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- This value determined from sample failure population. 100% tested to this value in production.
- ① When mounted on 1" square PCB (FR-4 or G-10 Material) . application note #AN-994
- junction temperature. Package limitation current is 42A

International

TOR Rectifier

#### **Ordering Information**

Base part	Package Type	Standard Pack		Standard Pack		Complete Part Number
		Form	Quantity			
AUIRFR2905Z	DPak	Tube	75	AUIRFR2905Z		
		Tape and Reel	2000	AUIRFR2905ZTR		
		Tape and Reel Left	3000	AUIRF2905ZSTRL		
		Tape and Reel Right	3000	AUIRF2905ZSTRR		

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#### AUIRFR2905Z

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IR products are neither designed nor intended for use in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements

For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

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